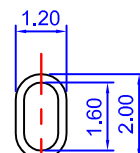
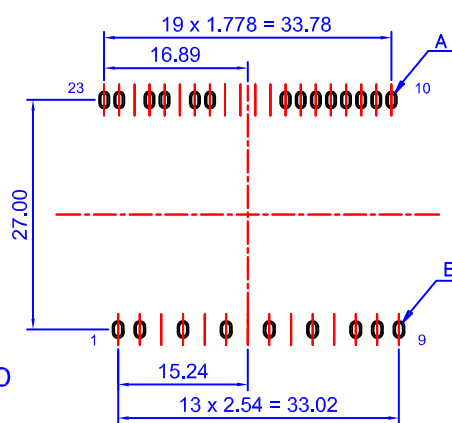
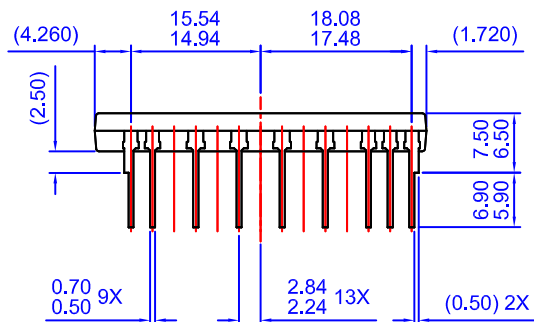
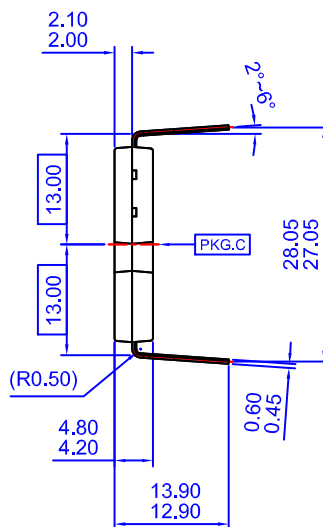
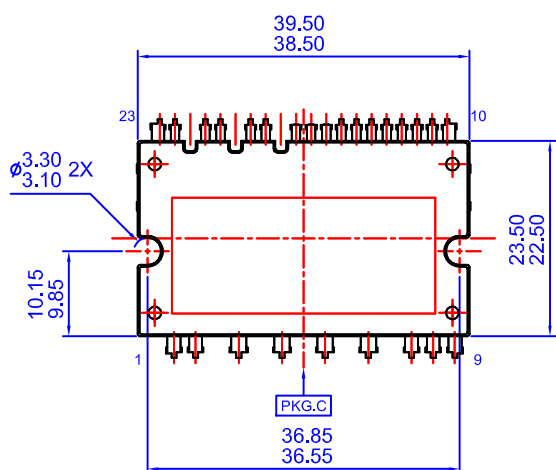
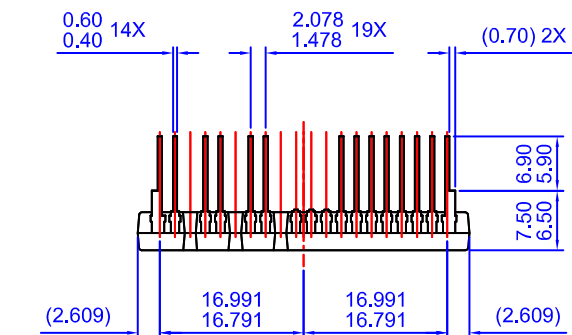
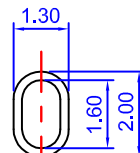


SPMAA-F26 / 23LD, SPM26-AAF (23LEAD), LONG LEAD, DUAL FORM STAND OFF OPTION 2.5MM
CASE MODEV
ISSUE O

DATE 31 JAN 2017



DETAIL A
(SCALE N/A)



DETAIL B
(SCALE N/A)

LAND PATTERN RECOMMENDATIONS

- NOTES: UNLESS OTHERWISE SPECIFIED**
A) THIS PACKAGE DOES NOT COMPLY TO ANY CURRENT PACKAGING STANDARD
B) ALL DIMENSIONS ARE IN MILLIMETERS
C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
D) () IS REFERENCE

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DESCRIPTION:	SPMAA-F26 / 23LD, LONG LEAD, DUAL STANDOFF OPTION 2.5MM	PAGE 1 OF 1

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